
**Soft soldering fluxes — Test
methods —**

**Part 16:
Flux efficacy test, wetting balance
method**

iTeh STANDARD PREVIEW
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Partie 16: Essai d'efficacité du flux, méthode à la balance de
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Foreword

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular, the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives).

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. ISO shall not be held responsible for identifying any or all such patent rights. Details of any patent rights identified during the development of the document will be in the Introduction and/or on the ISO list of patent declarations received (see www.iso.org/patents).

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For an explanation of the voluntary nature of standards, the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the World Trade Organization (WTO) principles in the Technical Barriers to Trade (TBT) see www.iso.org/iso/foreword.html.

This document was prepared by Technical Committee ISO/TC 44, *Welding and allied processes*, Subcommittee SC 12, *Soldering materials*.

This third edition cancels and replaces the second edition (ISO 9455-16:2013), of which it constitutes a minor revision.

The main changes compared to the previous edition are as follows:

- Clause 2 has been updated;
- the coding of the fluxes has been updated in accordance with ISO 9454-1:2016;
- the format of this document has been updated.

A list of all parts in the ISO 9455 series can be found on the ISO website.

Any feedback or questions on this document should be directed to the user's national standards body. A complete listing of these bodies can be found at www.iso.org/members.html.

Soft soldering fluxes — Test methods —

Part 16:

Flux efficacy test, wetting balance method

1 Scope

This document specifies a method for the assessment of the efficacy of a soft soldering flux, known as the wetting balance method. It gives a qualitative assessment of the comparative efficacy of two fluxes (for example, a standard and a test flux), based on their capacity to promote wetting of a metal surface by liquid solder. The method is applicable to all flux types in liquid form classified in ISO 9454-1.

NOTE It is hoped that future developments using improved techniques for obtaining a reproducible range of test surfaces will enable this method for assessing flux efficacy to be quantitative. For this reason, several alternative procedures for preparing the surface of the test piece are included in the present method.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO 9454-1, *Soft soldering fluxes — Classification and requirements — Part 1: Classification, labelling and packaging*
<https://standards.iteh.ai/catalog/standards/sist/45451466-150f428d-a198-406290875-452-2019>

IEC 60068-2-20:2008, *Environmental testing — Part 2-20: Tests — Test T: Test methods for solderability and resistance to soldering heat of devices with leads*

IEC 60068-2-69, *Environmental testing — Part 2-69: Tests — Test Te/Tc: Solderability testing of electronic components and printed boards by the wetting balance (force measurement) method*

IEC 60068-2-78:2012, *Environmental testing — Part 2-78: Tests; Test Cab: Damp heat, steady state*

3 Terms and definitions

No terms and definitions are listed in this document.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- ISO Online browsing platform: available at <https://www.iso.org/obp>
- IEC Electropedia: available at <http://www.electropedia.org/>

4 Symbols

- d depth of immersion, in millimetres, of the test piece below the undisturbed solder level
- A cross-sectional area, in square millimetres, of the test piece at the solder line
- ρ density, in grams per millilitre, of the solder under test at the test temperature
- F wetting force, in millinewtons

- t_0 time at which the test piece first makes contact with the surface of the liquid solder in the bath
- t_1 time at which the solder starts to wet the test piece (point A, see [Figure 1](#)), at which point the trace begins to fall
- t_2 time at which the recorded force is equal to the upward force due to buoyancy
- t_3 time at which the trace crosses the reference line

5 Principle

The efficacy of the liquid flux under test is compared with that of a standard liquid flux, using a wetting balance in conjunction with a specified test piece, appropriate to the class of flux under test.

The fluxes under test shall correspond to one of the classes defined in ISO 9454-1 and fulfil the requirements of ISO 9454-1.

6 Reagents

Use only reagents of recognized analytical quality and only distilled or deionized water.

6.1 Acid cleaning solution, prepared as follows:

Add cautiously, while stirring, 75 ml of sulfuric acid ($\rho = 1,84$ g/ml) to 210 ml of water and mix. Cool the solution to room temperature. Add 15 ml of nitric acid ($\rho = 1,42$ g/ml) and mix thoroughly.

6.2 Acetone.

6.3 Propan-2-ol, complying with the following requirements:

- propan-2-ol: 99,5 % (by mass) minimum;
- acid content: 0,002 % (by mass) maximum;
- non-volatile content: 0,2 % (by mass) maximum.

Isopropyl alcohol (also propan-2-ol, 2-propanol or the abbreviation IPA) is a common name for this chemical compound, which has the molecular formula C_3H_8O .

7 Apparatus

Usual laboratory apparatus and, in particular, the following.

7.1 Wetting balance and ancillary instrumentation, in accordance with IEC 60068-2-69.

Calibrate the apparatus in accordance with the manufacturer's instructions.

7.2 Solder bath.

As a minimum, the bath temperature shall be capable of being maintained at a temperature corresponding to the liquidus temperature of the alloy under test plus 35 °C. The test temperature shall be reported in the test report.

The dimensions of the solder bath shall be such that no portion of the test piece (see [Clause 8](#)) is less than 15 mm from the wall of the bath and the depth of the liquid solder in the bath shall be not less than 30 mm.

The solder used for the test and the test temperature may be one of the following:

- Sn60Pb40 (see ISO 9453) at 235 °C ± 3 °C;
- Sn96,5Ag3,0Cu0,5 (see ISO 9453) at 255 °C ± 3 °C;
- any other solder and temperature combinations as agreed between the customer and the flux supplier.

7.3 Acid-free filter paper.

8 Test pieces

The test pieces shall be made of copper.

EXAMPLE Test pieces are cut from a rectangular copper sheet. The dimensions of each test piece are as follows:

- width: 10,0 mm ± 0,1 mm;
- length: constant between 15 mm and 30 mm, to suit the equipment used;
- thickness: either 0,10 mm ± 0,02 mm or 0,30 mm ± 0,05 mm.

When testing fluxes of type 1 or 2 (as defined in ISO 9454-1), full details of the test pieces shall be given in the test report.

The sheet or other article used for preparing the test pieces shall be clean and free from contamination. In order to obtain accurate results, the test pieces shall be cut cleanly without leaving significant burrs.

9 Procedure ISO 9455-16:2019 <https://standards.iteh.ai/catalog/standards/sist/45451466-150f428d-a198-0cb025d9808c/iso-9455-16-2019>

9.1 Preparation of the test pieces

9.1.1 Cleaning

The test pieces shall be handled with clean tongs throughout. Select sufficient test pieces (see [Clause 8](#)) to allow 10 per test flux and 10 per standard flux. Degrease them in acetone ([6.2](#)) and allow to dry. Immerse them for 20 s in the acid cleaning solution ([6.1](#)) at room temperature. Remove the test pieces from the acid cleaning solution and wash for about five seconds under running tap water. Rinse with distilled or deionized water then acetone ([6.2](#)) and dry with acid-free filter paper ([7.3](#)).

If required, the test pieces may be stored in acetone after rinsing them in deionized water. When needed, they shall be removed from the acetone and dried with acid-free filter paper ([7.3](#)).

Subject all the test pieces to one of the ageing procedures given in [9.1.2](#) to [9.1.4](#) as agreed between the flux supplier and the customer.

9.1.2 Ageing the surface by sulfidation process

Carry out the procedure given in [Annex B](#) on all the cleaned test pieces (see [9.1.1](#)).

9.1.3 Steam ageing the surface

Carry out the steam ageing procedure given in IEC 60068-2-20:2008, 4.1.1, ageing procedure 1b, for a period of 4 h on all the cleaned test pieces (see [9.1.1](#)).

9.1.4 Damp-heat, steady-state ageing

Subject all the cleaned pieces (see [9.1.1](#)) to the test chamber conditions specified in IEC 60068-2-78:2012, Clause 4, for a period selected from 1 h, 4 h or 24 h.

9.2 Test method

9.2.1 Carry out the following test procedure on each of the 10 test pieces. Complete all 10 tests within 45 min of the preparation stage (see [9.1](#)).

9.2.2 If the flux under test is of type 1 or type 2 (as defined in ISO 9454-1), maintain the temperature of the solder bath at $235\text{ °C} \pm 3\text{ °C}$ or $255\text{ °C} \pm 3\text{ °C}$ (see [7.2](#)).

When testing fluxes which are not type 1 or type 2 (as defined in ISO 9454-1), the bath temperature requirements and the standard flux to be used for comparison shall be agreed between the flux supplier and the customer.

9.2.3 Remove one of the test pieces from the acetone, dry it between two sheets of acid-free filter paper ([7.3](#)) and place it in the wetting balance specimen clip so that the long edges are vertical. Dip the test piece in the flux solution under test at room temperature, to a depth of no less than 3 mm greater than the depth selected for immersion of the test piece in the solder (see [9.2.5](#)). Avoid excess flux by withdrawing the test piece cornerwise from the flux. If excess flux is still visible, touch the corner of the test piece on clean filter paper.

9.2.4 Attach the specimen clip to the wetting balance, ensuring that the bottom edge of the test piece is horizontal and approximately 20 mm above the solder bath ([7.2](#)). Allow it to remain there for $20\text{ s} \pm 5\text{ s}$ so that the solvent in the flux can evaporate before the test commences. Some types of flux can require a drying time which is shorter or longer than $20\text{ s} \pm 5\text{ s}$. In these cases, the drying time shall be agreed between the flux supplier and the customer. During this drying period, adjust the suspension force signal and recorder trace to the desired zero position.

Immediately before starting the test, scrape the surface of the solder bath with a blade of suitable material to remove oxides.

9.2.5 Either by raising the solder bath or by lowering the test piece, dip the test piece into the molten solder at a speed of $20\text{ mm/s} \pm 5\text{ mm/s}$ to a depth of either $3\text{ mm} \pm 0,2\text{ mm}$ or $4\text{ mm} \pm 0,2\text{ mm}$.

Hold the test piece in this position for 5 s to 10 s and then withdraw it at a speed of $20\text{ mm/s} \pm 5\text{ mm/s}$. Record the wetting force against time for the period during which the test piece is in contact with the solder.

9.2.6 Repeat steps [9.2.2](#) to [9.2.5](#) for each of the remaining nine test pieces.

10 Reference value using standard flux

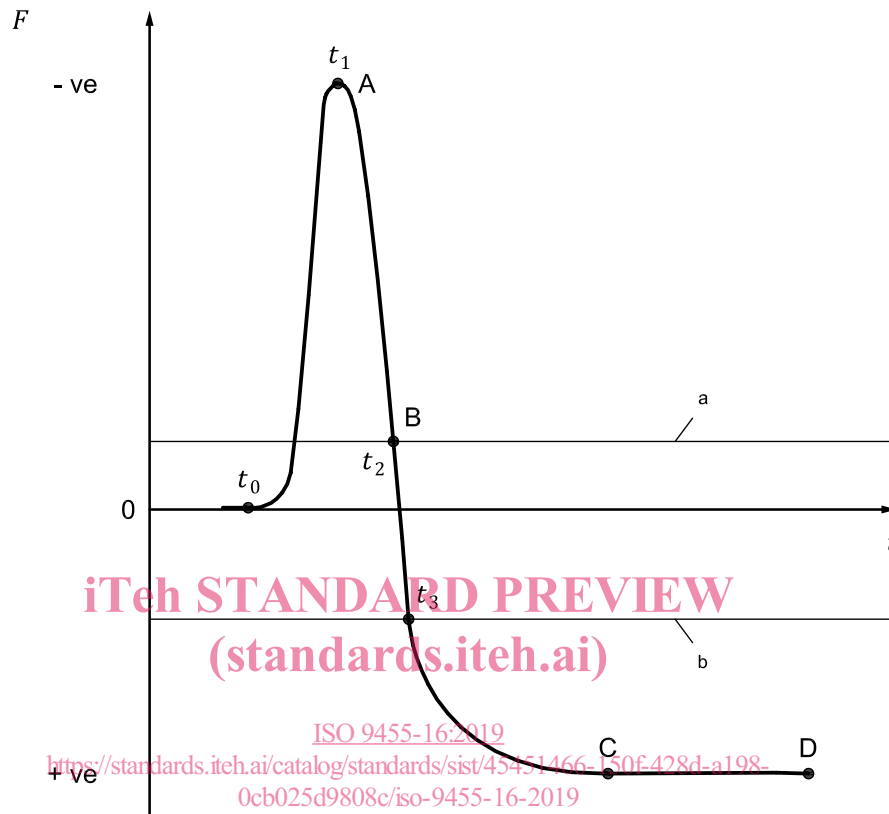
Carry out the procedure described in [Clause 9](#) using a further 10 test pieces (see [Clause 8](#)) but using a standard flux instead of the flux under test. If the flux under test is of type 1 or type 2 (as defined in ISO 9454-1), the standard flux prepared as described in [Annex A](#) shall be used. If the flux under test is of type 111 or 121 (as defined in ISO 9454-1), use the standard flux prepared as described in [A.5.1](#). If the flux under test is of type 112, 113, 122 or 123 (as defined in ISO 9454-1), use the standard flux prepared as described in [A.5.2](#).

If the flux under test is not of type 1 or type 2, use a standard flux as agreed by the supplier and customer (see [9.2.2](#), second paragraph).

11 Presentation of results

A typical trace of wetting force against time is given in [Figure 1](#).

In [Figure 1](#), non-wetting (upward) forces are shown as negative and wetting (downward) forces as positive.



Key

- F force
- t time
- a Test piece buoyancy line.
- b Wetting reference line.

Figure 1 — Recorded trace for wetting balance method showing significant points

The following are the points of significance in [Figure 1](#).

- Time t_0 is the moment at which the test piece first makes contact with the surface of the liquid solder in the bath. It is indicated by a sharp deviation of the recorder trace from the zero-force line.
- Time t_1 is the moment at which the solder starts to wet the test piece and corresponds to point A at which the trace begins to fall.
- Time t_2 , corresponding to point B, is the moment at which the recorded force is equal to the upward force due to buoyancy. The position of the test piece buoyancy line is calculated from the density of the solder and the depth of immersion of the test piece as follows.

Force at point B, in millinewtons, is equal to [Formula \(1\)](#):

$$\rho dA \times 9,81/1\,000 \quad (1)$$

where

- d is the depth of immersion, in millimetres, of the test piece below the undisturbed solder level;
- A is the cross-sectional area, in square millimetres, of the test piece at the solder line;
- ρ is the density, in grams per millilitre, of the solder under test at the test temperature.

Time t_3 is the moment at which the trace crosses the reference line. The line is drawn at a distance corresponding to a force, F , which depends on the test piece thickness and the immersion depth, as given in [Table 1](#).

Table 1 — Values of the wetting force as a function of test piece thickness and depth of immersion

Thickness mm	Immersion depth mm	Force, F mN
0,1	3	5,23
0,3	3	5,01
0,1	4	5,17
0,3	4	4,85

NOTE The force, F , is equal to 2/3 of the theoretical maximum wetting force on the test piece, assuming a wetting angle of zero and a liquid/vapour surface tension of 0,4 mN/mm.

Point C corresponds to the maximum value of the wetting force attained during the specified immersion period.

Point D corresponds to the end of the specified immersion period.

12 Calculation and expression of results

12.1 Carry out the procedures and calculations described in [12.2](#) and [12.3](#).

12.2 For each of the 10 recorded traces obtained for the sample flux, draw the test piece buoyancy line through point B (see [Clause 11](#)) and draw the wetting reference line 5,6 mN below the buoyancy line (see [Figure 1](#)). Read off the following times, in seconds:

- a) the time between t_0 and t_1 (i.e. the time to the start of wetting);
- b) the time between t_0 and t_3 (i.e. the time to reach a wetting force of 5,6 mN).

Calculate the mean values for a) and b) obtained from the 10 traces.

Measure the force corresponding to point C (i.e. the maximum wetting force). Calculate the mean value of the maximum wetting force.

12.3 Repeat the operations and calculations described in [12.2](#) for the 10 recorder traces obtained from the standard flux in order to obtain the mean values for a), b) and c) for the standard flux.

Compare the mean results for [12.2](#) a), b) and c) obtained for the flux under test with those obtained from the 10 results using the standard flux.

Then, assess the efficacy of the flux under test as better than, as good as, or worse than, the standard flux, in relation to the speed and strength of wetting.

13 Test report

The test report shall include the following information:

- a) the identification of the sample tested, including copper test specification, identification number and flux identifiers;
- b) the test method used (a reference to this document, i.e. ISO 9455-16);
- c) the test piece dimensions and, when fluxes of type 1 or type 2 were tested, full details of the test pieces (see [Clause 7](#));
- d) the ageing treatment (see [9.1.2](#) to [9.1.4](#));
- e) the test temperature (see [6.2](#));
- f) the depth of immersion of the test piece in the molten solder (see [9.2.5](#));
- g) details of the standard flux used for comparison;
- h) the results obtained;
- i) the nominal temperature range during the test and the actual temperature range recorded during the test;
- j) any unusual features noted during the procedure;
- k) details of any operation not specified in the method, or any optional operation which can have influenced the results;
- l) the date of the test.

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